



RoHS Compliance Statement

EU RoHS Directive 2011/65/EU and Amendment 2015/863/EU, restricts the below 10 substances and substance groups above the listed threshold at the homogeneous material level. Specific time-limited exemptions may be utilised as outlined in Annex III and Annex IV of the Directive.

Substance/Substance Group	Threshold
Cadmium/Cadmium Compounds (Cd)	0.01% at homogeneous material level
Lead/Lead Compounds (Pb)	0.1% at homogeneous material level
Hexavalent chromium and Compounds (Cr6+)	0.1% at homogeneous material level
Mercury/Mercury Compounds (Hg)	0.1% at homogeneous material level
Polybrominated biphenyls (PBB)	0.1% at homogeneous material level
Polybrominated diphenyl ethers (PBDE)	0.1% at homogeneous material level
Bis(2-ethylhexyl) phthalate (DEHP)	0.1% at homogeneous material level
Butyl benzyl phthalate (BBP)	0.1% at homogeneous material level
Dibutyl phthalate (DBP)	0.1% at homogeneous material level
Diisobutyl phthalate (DIBP)	0.1% at homogeneous material level

This declaration applies to the substance list version as of March 31, 2026.

Connection Technology Center, Inc. certifies that its supply base does not use any of the substances listed below on all product lines except piezo-ceramic based sensors. Our piezo accelerometers, velocity sensors, and loop power sensors utilize lead-containing piezoelectric ceramic materials (PZT). These devices are RoHS exempt under Annex III exemption 7(c)-VI, "Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectronic devices, or in a glass or ceramic matrix compound.

Charlotte Cook
Director of Marketing and Engineering